

GigaDevice Semiconductor Inc.

Arm[®] Cortex[®]-Mx 32-bit MCU

**Application Note
AN040**

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1. Introduction

IAP (In application programming) program can be used for MCU APP function upgrading by a pre-writing bootloader program, increasing the flexibility of code. After upgrading the APP code, the program needs to jump to APP program from Bootloader, this application note is writing for introduction of how to realize the program jumping from Bootloader to APP, basing on GD32F10x series.

2. IAP program

IAP program is commonly included by two parts: Bootloader and APP. Bootloader and APP are two projects, placing in different area of Main Flash, which is started from 0x08000000.

2.1. Program structure

2.1.1. Bootloader

Bootloader code structure is shown as below.

Table 2-1. Bootloader code

```

/*!
 \brief      main function
 \param[in]  none
 \param[out] none
 \retval     none
 */
int main(void)
{
    /* init modules ... */
    .....
    /* if no need to update APP */
    if(.....){
        /* Check if valid stack address (RAM address) then jump to user application */
        if (0x20000000 == ((*(__IO uint32_t*)USER_FLASH_BANK0_FIRST_PAGE_ADDRESS) &
0x2FFE0000)){
            /* disable all interrupts */
            nvic_irq_disable(EXTI0_IRQn);
            ...
            /* Jump to user application */
            JumpAddress = *(__IO uint32_t*) (USER_FLASH_BANK0_FIRST_PAGE_ADDRESS
+ 4);

            Jump_To_Application = (pFunction) JumpAddress;
            /* Initialize user application's Stack Pointer */
            __set_MSP(*(__IO uint32_t*) USER_FLASH_BANK0_FIRST_PAGE_ADDRESS);
            Jump_To_Application();
        } else {
            /* LED2 ON to indicate bad software (when not valid stack address) */
            gd_eval_led_on(LED2);
            /* do nothing */
            while(1){

```

```

    }
}

/* Bootloader codes for update APP areas */
} else {
    /* Bootloader realizing codes */
    /* including commands of operating flash */
    .....
    while (1){
        /* Bootloader realizing codes */
    }
}
}
}

```

2.1.2. APP

APP code structure is shown as below.

Table 2-2. APP code

```

/*!
 \brief      main function
 \param[in]  none
 \param[out] none
 \retval     none
*/
int main(void)
{
    /* set the NVIC vector table base address to APP code area */
    nvic_vector_table_set(NVIC_VECTTAB_FLASH, APP_OFFSET);
    /* enable global interrupt, the same as __set_PRIMASK(0) */
    __enable_irq();
    /* init modules ... */
    .....

    while (1){
        /* APP realizing codes */
    }
}
}

```

2.2. Project configuration

To upgrade APP code, the Bootloader code should be downloaded to Flash area started from 0x08000000 in advance, and the APP code must not overlap the Bootloader code. Follow the

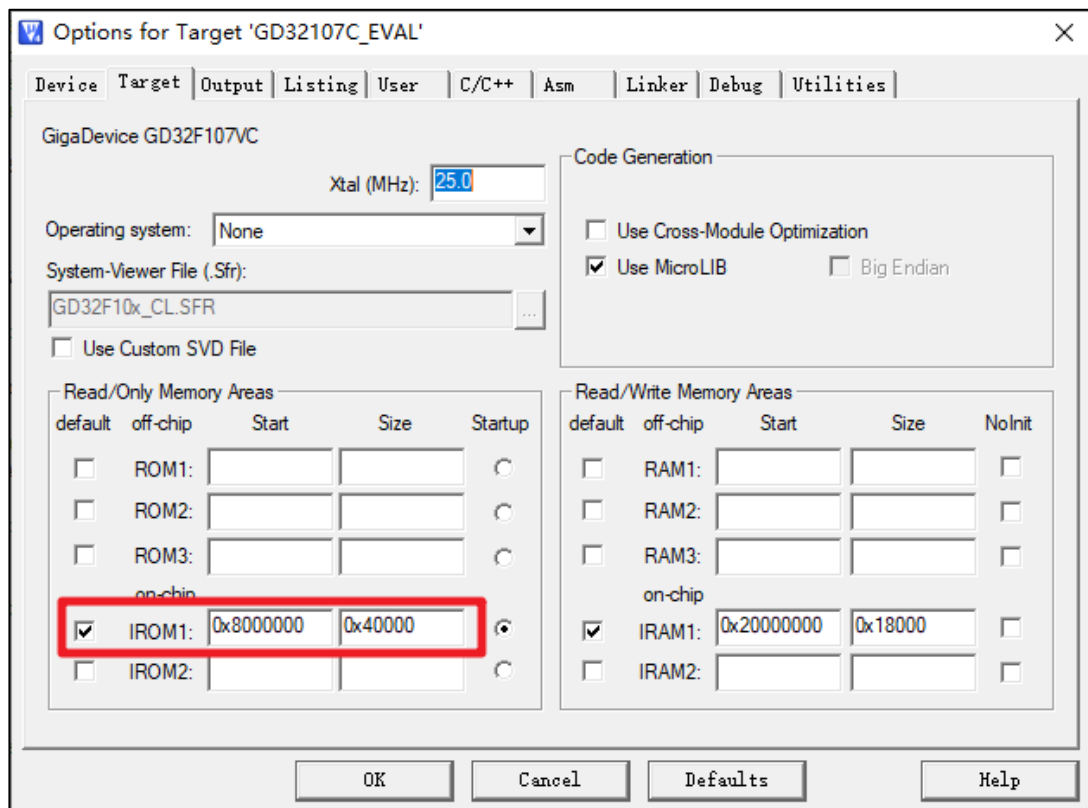
steps shown as below, take GD32F107VC as an example.

2.2.1. Bootloader

To ensure the APP code not overlap the Bootloader code, the Bootloader project should be configured in the following steps:

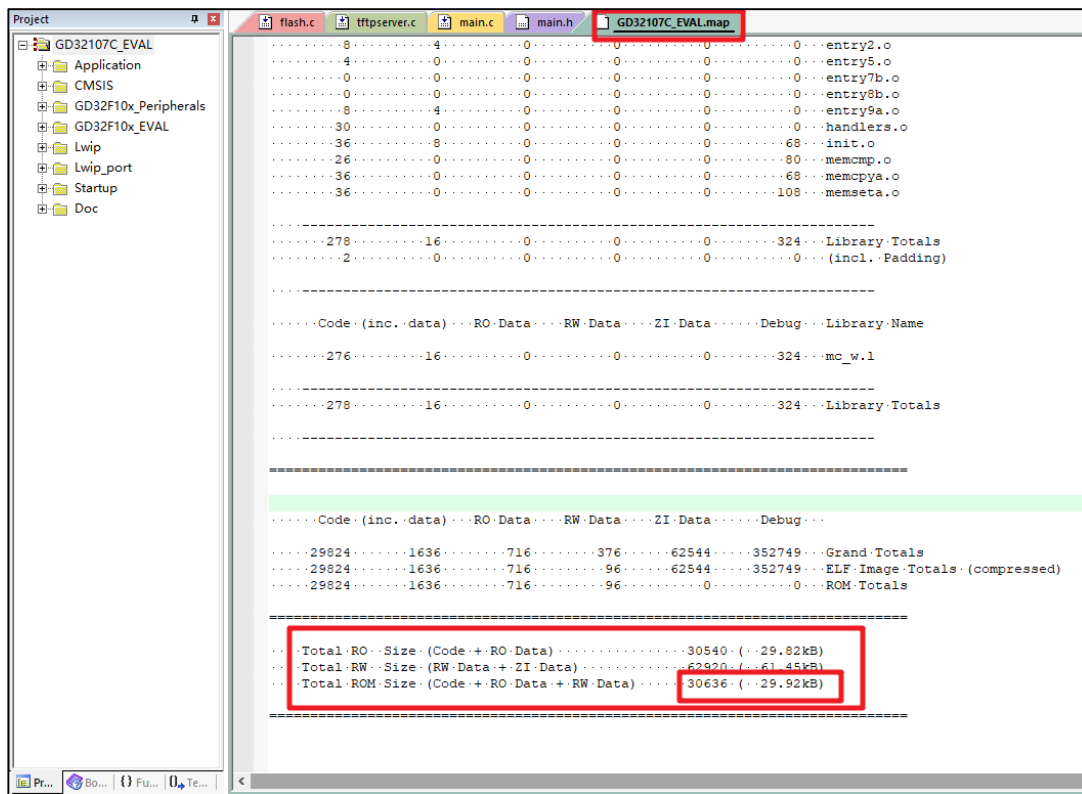
1. First, check the datasheet, flash size is 256KB, so the project configuration is shown as below, confirm it is started from 0x08000000.

Figure 2-1. Bootloader project configuration



2. Check the map file which is produced by Bootloader building, confirm the code size, and we get 29.92KB, it is 0x77AE equally.

Figure 2-2. Bootloader project map file



3. Modify the related commands of writing or erasing APP Flash area in Bootloader code, modification is mainly about changing the start address of Flash area which is to be written or erased: the address changes to 0x08010000, which is defined by the macro USER_FLASH_BANK0_FIRST_PAGE_ADDRESS, it means there are 0x10000 bytes used for Bootloader code storage, and the size is larger than the Bootloader size 0x77AE bytes.

Figure 2-3. Commands of writing or erasing APP Flash in Bootloader project

```

209 static int IAP_tftp_process_write(struct udp_pcb *upcb, const ip_addr_t *to, int to_port)
210 {
211     tftp_connection_args *args = NULL;
212     /* This function is called from a callback,
213     * therefore interrupts are disabled,
214     * therefore we can use regular malloc... */
215     args = mem_malloc(sizeof *args);
216     if (!args) {
217         IAP_tftp_cleanup_wr(upcb, args);
218         return 0;
219     }
220
221     args->op = TFTP_WRQ;
222     args->to_ip.addr = to->addr;
223     args->to_port = to_port;
224     /* the block # used as a positive response to a WRQ is always 0!!! (see RFC1350) */
225     args->block = 0;
226     args->tot_bytes = 0;
227
228     /* set callback for receives on this UDP PCB (Protocol Control Block) */
229     udp_recv(upcb, IAP_wrq_recv_callback, args);
230
231     total_count = 0;
232
233     /* init flash */
234     FLASH_If_Init();
235
236     /* erase user flash area */
237     FLASH_If_Erase(USER_FLASH_BANK0_FIRST_PAGE_ADDRESS);
238
239     Flash_Write_Address = USER_FLASH_BANK0_FIRST_PAGE_ADDRESS;
240     /* initiate the write transaction by sending the first ack */
241     IAP_tftp_send_ack_packet(upcb, to, to_port, args->block);
242     return 0;
243 }
244

```

Figure 2-4. Macro of APP program address in Bootloader project

```

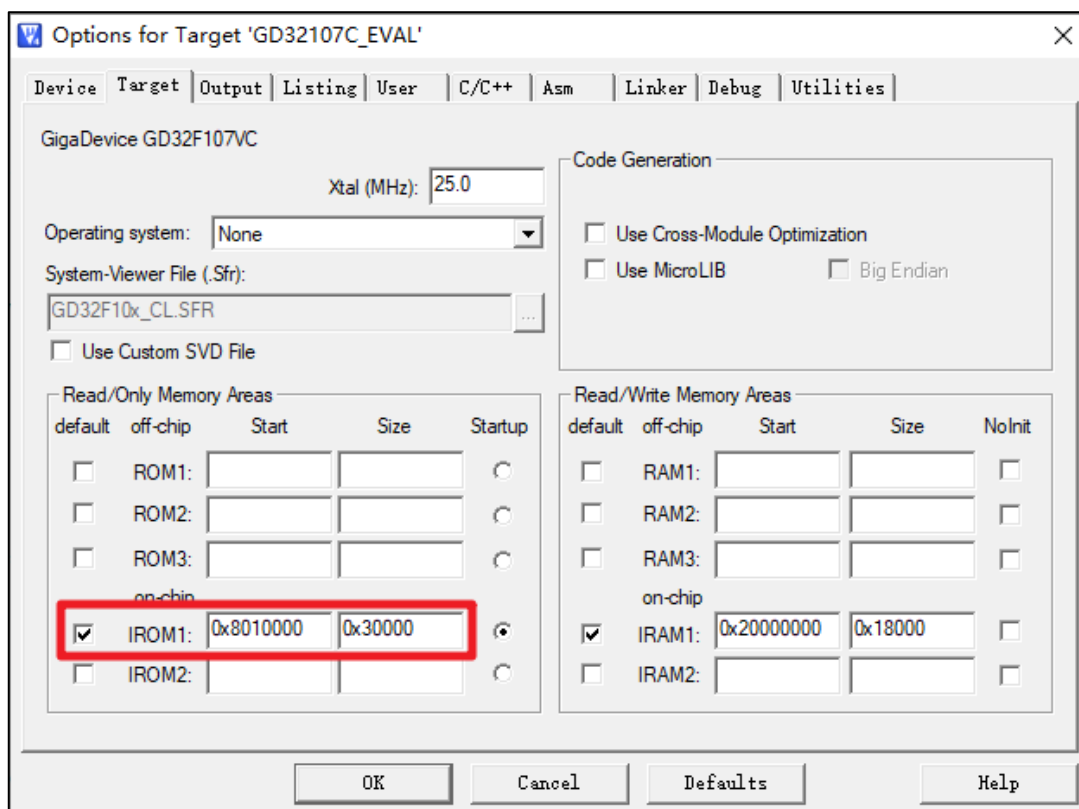
11  */
12
13  #ifndef __MAIN_H
14  #define __MAIN_H
15
16  #include "gd32f10x.h"
17  #include "stdint.h"
18  #include "gd32f10x_enet_eval.h"
19
20  /* #define USE_DHCP... */ /* enable DHCP, if disabled static address is used */
21
22  /* #define USE_ENET_INTERRUPT */
23  /* #define TIMEOUT_CHECK_USE_LWIP */
24
25  #define USER_FLASH_BANK0_FIRST_PAGE_ADDRESS 0x08010000 //user flash address start from
26  #define USER_FLASH_BANK0_LAST_PAGE_ADDRESS 0x0807f000 //user flash address start from
27
28  #define USER_FLASH_BANK1_LAST_PAGE_ADDRESS 0x082ff000 //user flash address start from
29  #define USER_FLASH_END_ADDRESS 0x082fffff
30

```

2.2.2. APP

APP project configuration is shown as below. Project code start address is set to 0x08010000, the same as the address which is to be written or erased in Bootloader code.

Figure 2-5. APP project configuration



2.3. Code explanation

There is a special code in Bootloader code and APP code, which is about how to jump from Bootloader to APP, and the code gives in chapter 2.1.1 is applied for Arm Cortex-M core jumping situation, detailed explanation is shown as below.

- if (0x20000000== ((*(_IO uint32_t*)USER_FLASH_BANK0_FIRST_PAGE_ADDRESS) & 0x2FFE0000))

Here the macro `USER_FLASH_BANK0_FIRST_PAGE_ADDRESS` is stored the APP program start address, while the APP program start address is stored the stack pointer (check the address before the vectors table in startup.s file). If the APP program is already downloaded, then the APP program start address is surely stored with the stack pointer, thus we can get the downloading situation of APP program by checking whether the stack pointer is located in SRAM area. SRAM size can be obtained by checking the MCU datasheet, in this case it is 96K, that is 0x18000 bytes, so we can check whether SP is among 0x20000000~0x20017FFF, to reach this goal, we can check bit 17-31 of SP, by logically 'and' with 0x2FFE0000, but this is not precisely correct, we can also use direct address comparing method. After judging, if the result is APP program already downloaded, the jumping action will be done continuously.

- `nvic_irq_disable(EXTI0_IRQn);`

Before jumping to APP program, it is necessary to disable all interrupts to avoid APP program running error or stuck at. One reason is that when running `__main` function of `Reset_Handler` function, the RAM area data will be initialized, if some interrupts are not disabled and just at this time, an interrupt occurs and changes some data of RAM, because the interrupt is the Bootloader program interrupt, the data change is not predictable and may lead to a running error of APP program. Another reason is that after jumping to APP program, due to no reset action of all modules, all module registers maintain configurations as before in Bootloader except the clock parameters which is reconfigured, if there are some interrupts are not disabled, while the corresponding module is still running as before in Bootloader program, and automatically triggers an interrupt, and there are no corresponding interrupt service routine in APP program for flag clearing, then the APP program may stuck at interrupt and running abnormally. So it is necessary to disable all interrupts.

- `JumpAddress = *(__IO uint32_t*) (USER_FLASH_BANK0_FIRST_PAGE_ADDRESS + 4);`

`Jump_To_Application = (pFunction) JumpAddress;`

The address of `USER_FLASH_BANK0_FIRST_PAGE_ADDRESS + 4` stores the `Reset_Handler` vector, which is the entry address of `Reset_Handler` function. Because `pFunction` is already self-defined as a void typed function pointer, the next command is to make the `Jump_To_Application` pointer point to the entry address of `Reset_Handler` function.

- `__set_MSP(*(__IO uint32_t*) USER_FLASH_BANK0_FIRST_PAGE_ADDRESS);`

Execute the first command of APP program, that is to set the main stack pointer point to the APP program start address `USER_FLASH_BANK0_FIRST_PAGE_ADDRESS`, prepare MSP to get ready for running APP program, for case of NMI or other fault before running the first command of `Reset_Handler` function, at this time, MSP is needed to provide stack.

- `Jump_To_Application();`

Execute the `Reset_Handler` function which the `Jump_To_Application` pointer point at, after executing `__main` function in `Reset_Handler` function, the program will jump to `main()` function, the APP main program part.

3. Revision history

Table 3-1. Revision history

Revision No.	Description	Date
1.0	Initial Release	Nov.30 2021

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